

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
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EPAS ID: PAT6935179

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
SATOSHI ENDO	08/04/2021
YOSHIMITSU IIDA	08/03/2021
YUTA ORIKASA	08/04/2021
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	HONDA MOTOR CO., LTD.
<b>Street Address:</b>	1-1, MINAMI-AOYAMA 2-CHOME
<b>Internal Address:</b>	MINATO-KU
<b>City:</b>	TOKYO
<b>State/Country:</b>	JAPAN
<b>Postal Code:</b>	107-8556
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
Application Number:	17484148
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(216)566-9711
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	2165669700
<b>Email:</b>	almasy@rankinhill.com
<b>Correspondent Name:</b>	RANKIN HILL AND CLARK LLP
<b>Address Line 1:</b>	38210 GLENN AVENUE
<b>Address Line 4:</b>	WILLOUGHBY, OHIO 44094
<b>ATTORNEY DOCKET NUMBER:</b>	ISN-51432
<b>NAME OF SUBMITTER:</b>	DAVID E. SPAW
<b>SIGNATURE:</b>	/David E. Spaw/
<b>DATE SIGNED:</b>	09/24/2021
This document serves as an Oath/Declaration (37 CFR 1.63).	
<b>Total Attachments: 6</b>	
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Honda Ref:H1201504U501

**DECLARATION (37 CFR 1.63) FOR UTILITY OR DESIGN APPLICATION USING AN APPLICATION DATA SHEET (37 CFR 1.76) AND ASSIGNMENT FOR SINGLE ASSIGNEE**

**Title of Invention : DOOR STRUCTURE AND METHOD OF ASSEMBLING VEHICLE DOOR**

As the below named inventor, I hereby declare that:

This declaration is directed to:

☒ The attached application, or

☐ United States application or PCT international application number \_\_\_\_\_  
filed on \_\_\_\_\_

The above-identified application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

WHEREAS, HONDA MOTOR CO., LTD. (hereinafter referred to as "ASSIGNEE") having a place of business at: 1-1, Minami-Aoyama 2-chome, Minato-ku, Tokyo, 107-8556 Japan, is desirous of acquiring the entire right, title and interest in and to said invention and in and to any Letters Patent that may be granted therefore in the United States and its territorial possessions and in any and all foreign countries;

NOW, THEREFORE, for good, valuable, and adequate consideration, the receipt and sufficiency of which are hereby acknowledged, I, by these presents do sell, assign and transfer unto said ASSIGNEE, the full and exclusive right to the said invention in the United States and its territorial possessions and in all foreign countries (including the right to claim priority under the terms of the International Convention and other relevant International Treaties and Arrangements from the aforesaid application) and the entire right, title and interest in and to any and all patent applications, patent rights, Letters Patent, and inventor's certificates which may be granted therefor in the United States and its territorial possessions and in any country in the world and in and to any and all divisions, reissues, continuations, substitutions and renewals thereof, and including without limitation the right to sue for past infringement thereunder.

I hereby authorize and request the Patent Office Officials in the United States and its territorial possessions and any and all foreign countries to issue any and all of said Letters Patent, when granted, to said ASSIGNEE as the assignee of my entire right, title and interest in and to the same, for the sole use and benefit of said ASSIGNEE, its successors and assigns, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held by me had this Assignment and sale not been made.

Further, I agree that I will communicate to said ASSIGNEE or its representatives any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuation, substitute, renewal and reissue applications, execute all necessary assignment papers to cause any and all of said Letters Patent to be issued to said ASSIGNEE, make all rightful oaths, and, generally do everything possible to aid said ASSIGNEE, its successors and assigns, to obtain and enforce proper protection for said invention in the United States and its territorial possessions and in any and all foreign countries.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

/Inventor's Signature/   Printed Name in English   Date

1. / Satoshi Endo / Satoshi ENDO   Aug 4, 2021

2. /                      / Yoshimitsu IIDA \_\_\_\_\_

3. /                      / Yuta ORIKASA \_\_\_\_\_

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1. /                      / Satoshi ENDO \_\_\_\_\_

2. /Yoshimitsu Iida/ Yoshimitsu IIDA \_Aug 03, 2021

3. /                      / Yuta ORIKASA \_\_\_\_\_

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2. /                      / Yoshimitsu IIDA \_\_\_\_\_

3. /Yuta Orikasa / Yuta ORIKASA Aug 4,2021